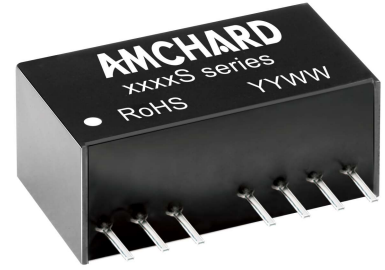


Product Feature

1. Universal Input: 8:1
2. Package Type: SIP8
3. Operating temperature range: -40°C - +85°C
4. Isolation voltage: 3000VDC
5. High efficiency up to: 79% (Type)
6. Equipped with input undervoltage protection, output short circuit protection, and overcurrent protection mechanisms



3 years Warranty

Selection Guide

Part No.	Input Voltage (VDC)	Max value	Out Voltage (VDC)	Out Current (mA) MAX	Full Load Efficiency % (Typ.)	Capacitive Load(μF) Max.
ABF1205S-3WR3	12 (4.5-36)	40	5	600	77	1000
ABF1212S-3WR3	12 (4.5-36)	40	12	250	79	330
ABF1215S-3WR3	12 (4.5-36)	40	15	200	79	220
ABE1205S-3WR3	12 (4.5-36)	40	±5	±300	77	#470
ABE1212S-3WR3	12 (4.5-36)	40	±12	±125	79	#220
ABE1215S-3WR3	12 (4.5-36)	40	±15	±100	79	#100

Input Specifications

Item	Operating Conditions	Min.	Typ.	Max.	Unit
Input Current(full load/no load)	12VDC Input	--	306/60	--	mA
Reflected Ripple Current	12VDC Input	--	15	--	
Impulse Voltage	12VDC Input	-0.7	--	25	VDC
Starting Voltage	12VDC Input	3	4	4.5	
Undervoltage Protection	12VDC Input	--	--	4	
Input Filter		Capacitance Filter			
Hot Plug		Unavailable			

Output Specifications

Item	Operating Conditions	Min.	Typ.	Max.	Unit
Output Voltage Accuracy	0% - 100% Load	--	±1.0	--	%
Linear Regulation	Full load, Input voltage from low limit to high limit	--	±0.3	±0.5	
Load Regulation	10% - 100% Load	--	±0.5	±1.0	
Ripple & Noise	20MHZ Bandwidth	--	50	150	mV
Transient Recovery Time	25% load step change	--	300	500	ms
Transient Response Deviation	25% load step change	--	±3	±5	%

Temperature Coefficient	Full Load	--	±0.01	±0.02	%/°C
Over Current Protection		110	140	--	%
Short-circuit Protection		Continuous, Self-Recovery			

General Specifications

Item	Operating Conditions	Min.	Typ.	Max.	Unit
Insulation Voltage	Input-output, test time 1 minute, leakage current less than 1mA	3000	--	--	VDC
Insulation Resistance	Input-output, insulated voltage 500VDC	1000	--	--	MΩ
Isolation Capacitance	Input-output, 100KHz/0.1V	--	40	--	pF
Operating Temperature	Derating when operating temperature ≥ 85°C (See Figure 1)	-40	--	85	°C
Storage Temperature		-55	--	125	°C
Storage Humidity	Non-condensing	5	--	95	%RH
Pin welding can withstand the highest temperature	Soldering spot is 1.5mm away from case for 10 seconds	--	--	300	°C
Switching Frequency	Full Load, Nominal Input Voltage	--	300	--	KHz
MTBF	MIL-HDBK-217F@25°C	>1000Kh			

Mechanical Specification

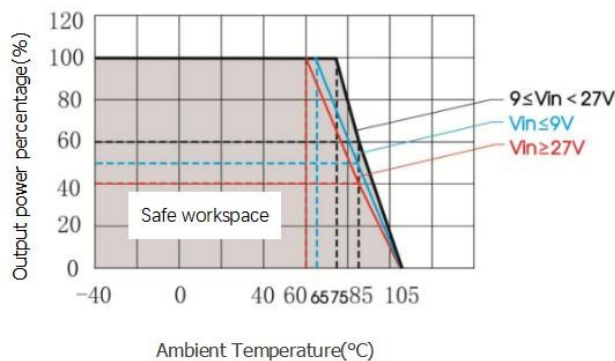
Case Material	Black plastic; flame-retardant and heat-resistant (UL 94V-0 rated)
Package Dimensions	22.00 x 9.50 x 12.00mm
Weight	3.8g (Typ.)
Cooling Method	Free air convection

EMC Specifications

EMI	CE	CISPR32/EN55032 CLASS B (Application circuit 3)
	RE	CISPR32/EN55032 CLASS B (Application circuit 3)
EMS	ESD	IEC/EN61000-4-2 Contact±8KV perf. Criteria B

Typical Characteristic Curves

Temperature Derating Curve (Figure 1)



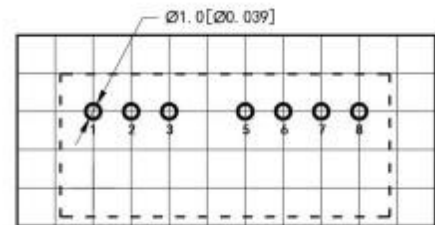
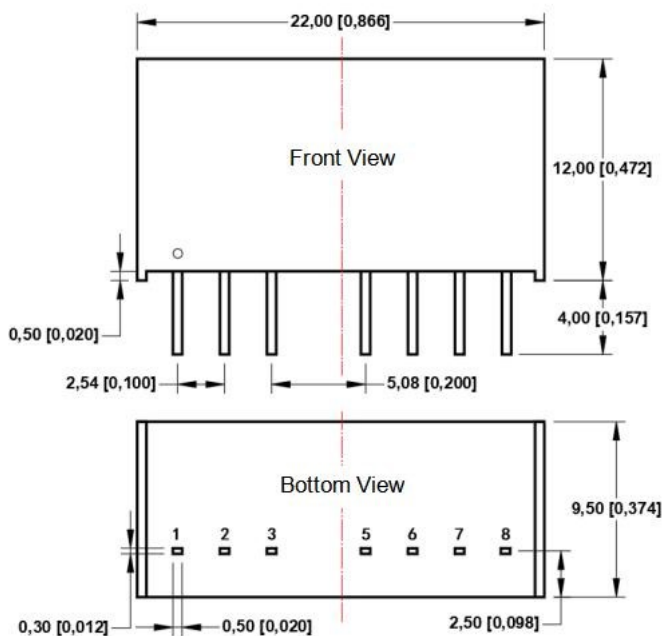
Typical Circuit Design and Application

Application circuit (Figure 2)	Recommended Capacitive Load Value Table						
	<table border="1"> <tr> <td>Vin</td> <td>12V</td> </tr> <tr> <td>Cin</td> <td>100uF</td> </tr> <tr> <td>Cout</td> <td>22uF</td> </tr> </table>	Vin	12V	Cin	100uF	Cout	22uF
Vin	12V						
Cin	100uF						
Cout	22uF						

Application circuit (Figure 3)	EMI Recommended Parameter Table																		
	<table border="1"> <tr> <td>Model</td> <td>Vin : 12V</td> </tr> <tr> <td>FUSE</td> <td>Select according to the actual input current of the customer</td> </tr> <tr> <td>C0</td> <td>1000uF/50V</td> </tr> <tr> <td>C4</td> <td>330uF/50V</td> </tr> <tr> <td>C1/C2/C3</td> <td>10uF/50V</td> </tr> <tr> <td>LCM1</td> <td>3.3mH</td> </tr> <tr> <td>LDM1</td> <td>4.7uH</td> </tr> <tr> <td>CY1/CY2</td> <td>1nF/3KV</td> </tr> <tr> <td>C5/C6</td> <td>Refer to the Cout parameters in Figure 2</td> </tr> </table>	Model	Vin : 12V	FUSE	Select according to the actual input current of the customer	C0	1000uF/50V	C4	330uF/50V	C1/C2/C3	10uF/50V	LCM1	3.3mH	LDM1	4.7uH	CY1/CY2	1nF/3KV	C5/C6	Refer to the Cout parameters in Figure 2
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CY1/CY2	1nF/3KV																		
C5/C6	Refer to the Cout parameters in Figure 2																		

Dimensions and Recommended Layout

Dimensions	PCB Printing Layout
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The grid distance is 2.54mm x2.54mm

Note:
 Unit: mm[inch]
 Pin section tolerances: ±0.10[±0.004]
 General tolerances: ±0.50[±0.020]

Pin Definition Table		
Pin	Function (single)	Function (double)
1	GND	GND
2	Vin	Vin
3	NC	NC
5	NC	NC
6	+Vo	+Vo
7	-Vo	COM
8	NC	-Vo

NC: Pin to be isolated from circuitry

Note:

1. The input voltage cannot exceed the specified range value, otherwise permanent and irreparable damage may be caused ;
2. If the product works under the minimum required load, it cannot guarantee that the performance of the product complies with all the performance indicators in this manual;
3. The maximum capacitive load is tested under the input voltage range and full load condition;
4. Unless otherwise stated, all indexes in this manual are measured at $T_a=25^{\circ}\text{C}$, humidity $<75\%RH$, nominal input voltage and rated output load;
5. All index testing methods in this manual are based on the enterprise standards of the company;
6. Our company can provide product customization, specific needs can directly contact our technical staff;